

#### **Features**

Complementary Pair.

One 3904-Type NPN.

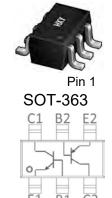
One 3906-Type PNP.

Epitaxial Planar Die Construction.

Ideal for Low Power Amplification and Switching.

### **Package Marking and Ordering Information**

Product ID	Product ID Pack		Qty(PCS)	
MMDT3946	SOT-363	K46	3000	



Maxmim Ratings (Ta=25 unless otherwise noted)

Pin 1

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	60	V
V <sub>CEO</sub>	Collector-Emitter Voltage	40	V
V <sub>EBO</sub>	Emitter-Base Voltage	5	V
Ic	Collector Current	200	mA
Pc	Collector Power Dissipation	200	mW
R <sub>OJA</sub>	Thermal Resistance From Junction To Ambient	625	°C/W
T <sub>J</sub> ,T <sub>stg</sub>	Operation Junction And Storage Temperature Range	-55~+150	$^{\circ}$

## NPN 3904 Electrcal Charcteristics (Ta=25 unless otherwise noted)

Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
V <sub>(BR)CBO</sub>	Collector-base breakdown voltage	I <sub>C</sub> =10μΑ, I <sub>E</sub> =0	60			V
V <sub>(BR)CEO</sub>	Collector-emitter breakdown voltage	I <sub>C</sub> =1mA, I <sub>B</sub> =0	40			V
$V_{(BR)EBO}$	Emitter-base breakdown voltage	I <sub>E</sub> =10μΑ, I <sub>C</sub> =0	5			V
I <sub>CEO</sub>	Collector cut-off current	V <sub>CE</sub> =30V, I <sub>B</sub> =0			50	nA
I <sub>CBO</sub>	Collector cut-off current	V <sub>CB</sub> =30V, I <sub>E</sub> =0			50	nA
I <sub>EBO</sub>	Emitter cut-off current	V <sub>EB</sub> =5V, I <sub>C</sub> =0			50	nA
h <sub>FE</sub> (1)	DC current gain(1)	V <sub>CE</sub> =1V, I <sub>C</sub> =100μA	40			
h <sub>FE</sub> (2)	DC current gain(2)	V <sub>CE</sub> =1V, I <sub>C</sub> =1mA	70			
h <sub>FE</sub> (3)	DC current gain(3)	V <sub>CE</sub> =1V, I <sub>C</sub> =10mA	100		300	
h <sub>FE</sub> (4)	DC current gain(4)	V <sub>CE</sub> =1V, I <sub>C</sub> =50mA	60			
h <sub>FE</sub> (5)	DC current gain(5)	V <sub>CE</sub> =1V, I <sub>C</sub> =100mA	30			
.,	Collector-emitter saturation voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =1mA			0.2	V
$V_{CE(sat)}$		I <sub>C</sub> =50mA, I <sub>B</sub> =5mA			0.3	V
.,	Base-emitter saturation voltage	I <sub>C</sub> =10mA, I <sub>B</sub> =1mA	0.65		0.85	V
$V_{BE(sat)}$		I <sub>C</sub> =50mA, I <sub>B</sub> =5mA			0.95	V
f⊤	Transition frequency	V <sub>CE</sub> =20V, I <sub>C</sub> =10mA, f=100MHz	300			MHz
Cob	Collector output capacitance	V <sub>CB</sub> =5V, I <sub>E</sub> =0, f=1MHz			4	pF
NF	Noise figure	$V_{CE}$ =5V,Ic=0.1mA,f=1kHz,Rg=1K $\Omega$	V,lc=0.1mA,f=1kHz,Rg=1KΩ		5	dB
t <sub>d</sub>	Delay time	V <sub>CC</sub> =3V, V <sub>BE(off)</sub> =0.5V,			35	ns
t <sub>r</sub>	Rise time	I <sub>C</sub> =10mA, I <sub>B1</sub> =I <sub>B2</sub> =1mA			35	ns
ts	Storage time	V <sub>CC</sub> =3V, I <sub>C</sub> =10mA,			225	ns
t <sub>f</sub>	Fall time	I <sub>B1</sub> =I <sub>B2</sub> =1mA			75	ns



Maxmim Ratings (Ta=25 unless otherwise noted)

Symbol	Parameter	Value	Unit
V <sub>CBO</sub>	Collector-Base Voltage	-40	V
V <sub>CEO</sub>	Collector-Emitter Voltage	-40	V
V <sub>EBO</sub>	Emitter-Base Voltage	-5	V
Ic	Collector Current	-200	mA
Pc	Collector Power Dissipation	200	mW
R <sub>OJA</sub>	Thermal Resistance From Junction To Ambient	625	°C/W
T <sub>J</sub> ,T <sub>stg</sub>	Operation Junction And Storage Temperature Range	-55~+150	${\mathbb C}$

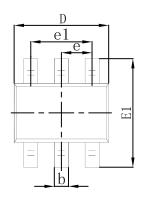
# PNP 3906 Electrcal Charcteristics (Ta=25 unless otherwise noted)

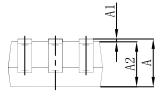
Symbol	Parameter	Test conditions	Min	Тур	Max	Unit
V <sub>(BR)CBO</sub> *	Collector-base breakdown voltage	I <sub>C</sub> =-10μΑ, I <sub>E</sub> =0	-40			V
V <sub>(BR)CEO</sub> *	Collector-emitter breakdown voltage	I <sub>C</sub> =-1mA, I <sub>B</sub> =0 -40			V	
V <sub>(BR)EBO</sub> *	Emitter-base breakdown voltage	I <sub>E</sub> =-10μΑ, I <sub>C</sub> =0	-5			V
I <sub>CEX</sub> *	Collector cut-off current	V <sub>CE</sub> =-30V, V <sub>EB(off)</sub> =-3V			-50	nA
I <sub>CBO</sub>	Collector cut-off current	V <sub>CB</sub> =-30V, I <sub>E</sub> =0			-50	nA
I <sub>EBO</sub>	Base cut-off current	V <sub>EB</sub> =-5V,I <sub>E</sub> =0			-50	nA
h <sub>FE</sub> (1)*	DC current gain(1)	V <sub>CE</sub> =-1V, I <sub>C</sub> =-100μA	60			
h <sub>FE</sub> (2)*	DC current gain(2)	V <sub>CE</sub> =-1V, I <sub>C</sub> =-1mA	80			
h <sub>FE</sub> (3)*	DC current gain(3)	V <sub>CE</sub> =-1V, I <sub>C</sub> =-10mA	100		300	
h <sub>FE</sub> (4)*	DC current gain(4)	V <sub>CE</sub> =-1V, I <sub>C</sub> =-50mA	60			
h <sub>FE</sub> (5)*	DC current gain(5)	V <sub>CE</sub> =-1V, I <sub>C</sub> =-100mA	30			
., .	Collector-emitter saturation voltage	I <sub>C</sub> =-10mA, I <sub>B</sub> =-1mA			-0.25	V
$V_{CE(sat)}^*$		I <sub>C</sub> =-50mA, I <sub>B</sub> =-5mA			-0.4	V
	Base-emitter saturation voltage	I <sub>C</sub> =-10mA, I <sub>B</sub> =-1mA	-0.65		-0.85	V
$V_{BE(sat)}^*$		I <sub>C</sub> =-50mA, I <sub>B</sub> =-5mA			-0.95	V
f⊤	Transition frequency	V <sub>CE</sub> =-20V, I <sub>C</sub> =-10mA, f=100MHz	250			MHz
Cob	Collector output capacitance	V <sub>CB</sub> =-5V, I <sub>E</sub> =0, f=1MHz			4.5	pF
NF	Noise figure	VCE=-5V,lc=-0.1mA,f=1kHz,Rg=1KΩ			4	dB
t <sub>d</sub>	Delay time	V <sub>CC</sub> =-3V, V <sub>BE(off)</sub> =-0.5V,		35	ns	
t <sub>r</sub>	Rise time	I <sub>C</sub> =-10mA, I <sub>B1</sub> =I <sub>B2</sub> =-1mA		35	ns	
ts	Storage time	V <sub>CC</sub> =-3V, I <sub>C</sub> =-10mA,		225	ns	
t <sub>f</sub>	Fall time	I <sub>B1</sub> =I <sub>B2</sub> =-1mA		75	ns	

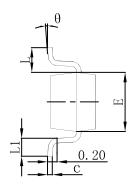
<sup>\*</sup>Pulse test: pulse width ≤300µs, duty cycle≤ 2.0%.



## **SOT-363 Package Outline Dimensions**

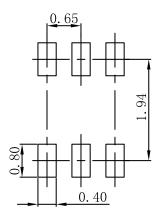






Symbol	Dimensions In Millimeters		Dimensions In Inches		
Syllibol	Min	Max	Min	Max	
Α	0.900	1.100	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.000	0.035	0.039	
р	0.150	0.350	0.006	0.014	
С	0.100	0.150	0.004	0.006	
D	2.000	2.200	0.079	0.087	
Е	1.150	1.350	0.045	0.053	
E1	2.150	2.400	0.085	0.094	
е	0.650	0.650 TYP 0.026 TYP		S TYP	
e1	1.200	1.400	0.047	0.055	
Ĺ	0.525 REF		0.525 REF 0.021		REF
L1	0.260	0.460	0.010	0.018	
θ	0°	8°	0°	8°	

# **SOT-363 Suggested Pad Layout**



#### Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
- 3. The pad layout is for reference purposes only.



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